IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Aron T. Lunde

Application No.:

10/053,963

Filed:

January 22, 2002

For:

A DIE ASSEMBLY AND METHOD

FOR FORMING A DIE ON A

WAFER

Confirmation No.:

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Group Art Unit:

2823

Examiner:

Nguyen, Khiem D.

Atty. Docket: MICS:0214/FLE/MAN/EUB

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October 1, 2007

/Lee Eubanks/

L. Lee Eubanks IV

AMENDMENT AND RESPONSE TO **OFFICE ACTION MAILED AUGUST 6, 2007**

Dear Sir:

In response to the Final Office Action mailed on August 6, 2007, Applicant respectfully requests reconsideration of the present application in view of the following amendments and remarks.